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FORM PTO-1595 (Rev. 6-93)	02-06-2001	'ER SHEET U.S. DEPARTMENT OF COMMERCE Patent and Trademark Office	
OMB No. 0651-0011 (exp. 4/94)		Y Y	
To the Honorable Commission	101605775	the attached original documents or copy thereof.	
1. Name of conveying party(ies):	101000110	2. Name and address of receiving party(ies):	
Gi-Sung Yeo	A 1	Name: Someway Electropics Co. Ltd.	
1. 16.	.0	Samsung Electronics, Co., Ltd.	
		Internal Address:	
Additional name(s) of conveying party(ies) attached	1? 🗆 Yes 🖾 No		
3. Nature of conveyance:		Street Address: 416, Maetan-dong, Paldal-gu,	
		Suwon-city, Kyungki-do, Republic of Korea	
⊠ Assignment	□ Merger		
Security Agreement	□ Change of Name	City: State ZIP	
\Box Other			
Execution Date: January 3, 200	1	Additional name(s) & address attached? □ Yes ⊠ No	
4. Application number(s) or patent number(s):			
If this document is being filed together w		ecution date of the application is: January 3, 2001	
A. Patent Application No.(s)		B. Patent No.(s)	
-			
09/76/618	Additional numbers attached?	I? □Yes ⊠No	
5. Name and address of party to whom co document should be mailed:	orrespondence concerning	6. Total number of applications and registrations 1	
Name: Steven M. Mills			
		7. Total fee (37 CFR 3.41) \$40.00	
Internal Address:			
Samuels, Gauthier & Stevens LLP	<u> </u>	Enclosed	
Street Address: 225 Franklin St		Authorized to be charged to deposit account	
225 Franklin St	reet, Suite 3300	8. Deposit Account Number:	
City: Boston State	MA ZIP 02110	(Attach duplicate copy of this page if paying by deposit account)	
DO NOT USE THIS SPACE			
9. Statement and signature:			
To the best of my knowledge and belief, the original document.	he foregoing information is tru	ue and correct and any attached copy is a true copy of the	
	n		
Steven M. Mills, Reg. No. 36,610 Steven Mills Januar 16, 2001			
Name of Person Signing Signature Date			
Total number of pages including cover sheet, attachments, and document 3			
Mail documents to be recorded with required cover sheet information to: Commissioner of Patents and Trademarks, Box Assignments			
Washington, D.C. 20231 K:\Samsung\139\PTO1595.wpd			
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		REEL: 011483 FRAME: 0359	

Docket No.: SAM-139

ASSIGNMENT

I, Gi-Sung Yeo of 6-206, Munjung Jukong Apt., Munjung 1-dong, Songpa-ku, Seoul, Republic of Korea, having invented improvements in MULTILAYER ALIGNMENT KEYS AND ALIGNMENT METHOD USING THE SAME described in an application for Letters Patent of the United States, executed by me on even date herewith, for good and valuable consideration, receipt of which is hereby acknowledged from Samsung Electronics Co., Ltd., a Korean corporation having a place of business at 416, Maetan-dong, Paldal-gu, Suwon-city, Kyungki-do, Republic of Korea (and hereinafter called the Assignee, which term shall include its successors and assigns), do hereby sell, assign and transfer unto the Assignee our entire right, title, and interest in and throughout the United States of America (including its territories and dependencies) and all countries foreign thereto, in and to and under said application (which term shall include hereinafter where the context so admits all divisional, continuing, reissue and other patent applications based thereon) and the inventions (which term shall include each and every such invention, or part thereof) therein described, and any and all patents and like rights of exclusion (including extensions thereof) of any country which may be granted on or for said inventions or on said application;

And for the same consideration I do also hereby sell, assign, and transfer unto the Assignee, all of my rights under the International Convention for the Protection of Industrial Property, the Patent Cooperation Treaty, and all other treaties of like purpose in respect of said inventions and said application, and I do hereby authorize the Assignee to apply in my name or its own name or its designee for patents and like rights of exclusion on or for said inventions in all countries, claiming (if the Assignee so desires) the priority of the filing date of said application under the provisions of said Convention, Treaty or any such other Convention or Treaty;

And for the same consideration, I do hereby agree for myself and for my heirs, executors, and administrators, promptly upon request of the Assignee to execute and deliver without further compensation any power of attorney, assignment, original, divisional, continuing, reissue or other application or applications for patent or patents or like rights of exclusion of any country, or other lawful documents and any further assurances that may be deemed necessary or desirable by the Assignee, fully to secure to it said right, title, and interest as aforesaid in and to said inventions, applications, and said several patents and like rights of exclusion (including extensions thereof) or any of them, all, however, at the expense of the Assignee, its successors, or assigns;

And I do hereby authorize and request the Commissioner of Patents and Trademarks of the United States of America and the corresponding Official of each country foreign thereto to issue to the Assignee, any and all patents and like rights of exclusion which may be granted in any country upon said United States application on or for said inventions;

And I do hereby covenant for myself and my legal representatives and agree with the Assignee, that I have granted no right or license to make, use, or sell said inventions to anyone except the Assignee, that prior to the execution of this deed our right, title, and interest in and to said inventions has not been otherwise encumbered by myself, and that I have not executed and will not execute any instruments in conflict herewith.

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First or Sole Inventor:

Signature:

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JZO bn-Sung Gi-Sung Yeo

Date: 2001.01.03

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RECORDED: 01/16/2001

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